

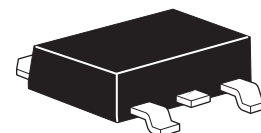
ZXMN7A11K

70V N-channel enhancement mode MOSFET

Summary

$V_{(BR)DSS}=70V : R_{DS(on)}=0.13\Omega$

$I_D=6.1A$

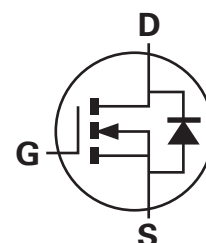


Description

This new generation of trench MOSFETs from Zetex utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage power management applications.

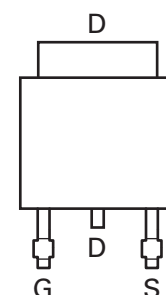
Features

- Low on-resistance
- Fast switching speed
- Low threshold
- Low gate drive
- DPAK package



Applications

- DC-DC converters
- Power management functions
- Disconnect switches
- Motor control
- Class D audio output stages



Pinout - top view

Ordering information

Device	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMN7A11KTC	13	16	2,500

Device marking

ZXMN
7A11

Absolute maximum ratings

Parameter	Symbol	Limit	Unit
Drain-source voltage	V_{DSS}	70	V
Gate-source voltage	V_{GS}	± 20	V
Continuous drain current @ $V_{GS}=10V$; $T_A=25^\circ C$ (b) @ $V_{GS}=10V$; $T_A=70^\circ C$ (b) @ $V_{GS}=10V$; $T_A=25^\circ C$ (a)	I_D	6.1 4.9 4.2	A
Pulsed drain current (c)	I_{DM}	17	A
Continuous source current (body diode) (b)	I_S	8.7	A
Pulsed source current (body diode) (c)	I_{SM}	17	A
Power dissipation at $T_A = 25^\circ C$ (a) Linear derating factor	P_D	4.06 32.4	W mW/ $^\circ C$
Power dissipation at $T_A = 25^\circ C$ (b) Linear derating factor	P_D	8.5 68	W mW/ $^\circ C$
Power dissipation at $T_A = 25^\circ C$ (d) Linear derating factor	P_D	2.11 16.8	W mW/ $^\circ C$
Operating and storage temperature range	T_j, T_{stg}	-55 to +150	$^\circ C$

Thermal resistance

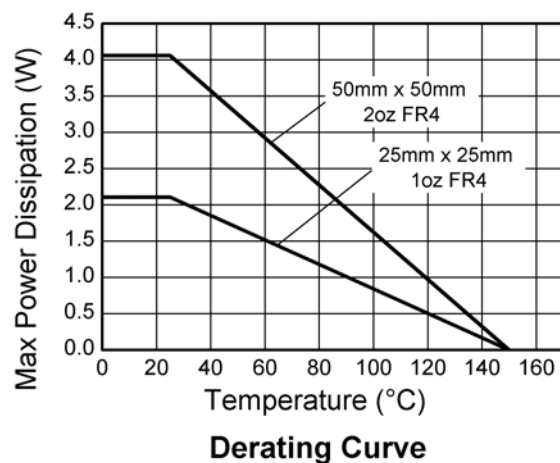
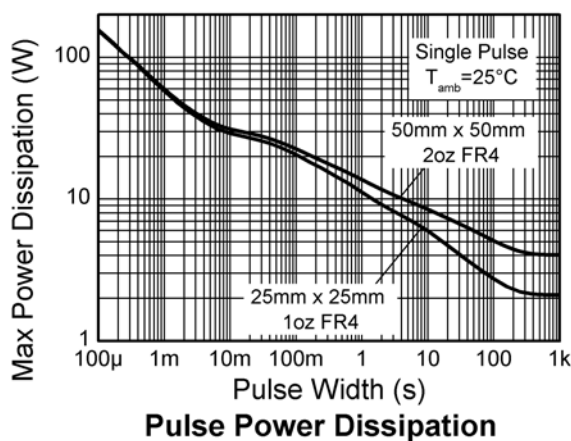
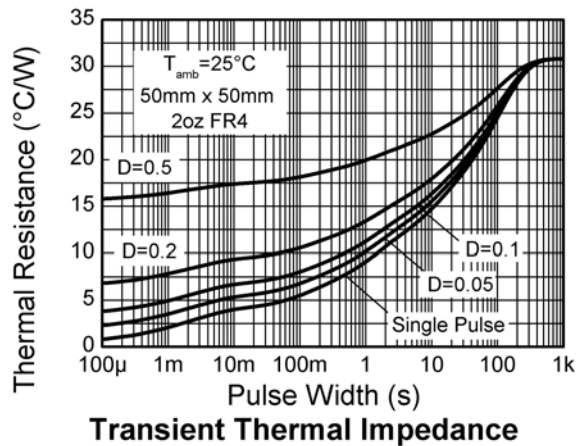
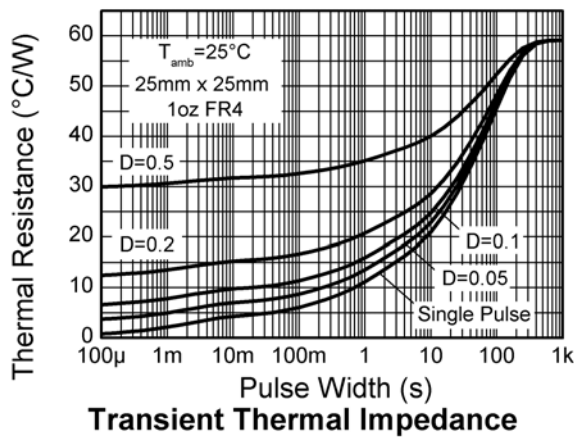
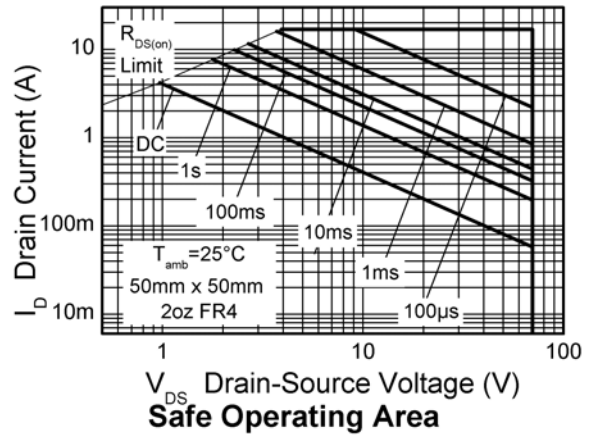
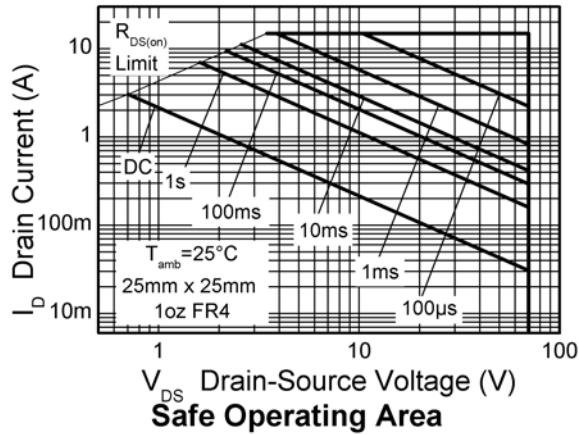
Parameter	Symbol	Limit	Unit
Junction to ambient	$R_{\theta JA}$	30.8	$^\circ C/W$
Junction to ambient	$R_{\theta JA}$	14.7	$^\circ C/W$
Junction to ambient	$R_{\theta JA}$	59.1	$^\circ C/W$

NOTES:

- (a) For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions.
- (b) For a device surface mounted on FR4 PCB measured at $t \leq 10$ sec.
- (c) Repetitive rating 50mm x 50mm x 1.6mm FR4 PCB, $D=0.02$ pulse width=300 μs - pulse width limited by maximum junction temperature.
- (d) For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

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Characteristics



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Electrical characteristics (at Tamb = 25°C unless otherwise stated)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Static						
Drain-source breakdown voltage	V _{(BR)DSS}	70			V	I _D = 250μA, V _{GS} =0V
Zero gate voltage drain current	I _{DSS}			1	μA	V _{DS} = 70V, V _{GS} =0V
Gate-body leakage	I _{GSS}			100	nA	V _{GS} =±20V, V _{DS} =0V
Gate-source threshold voltage	V _{GS(th)}	1.0			V	I _D = 250μA, V _{DS} =V _{GS}
Static drain-source on-state resistance ^(*)	R _{DS(on)}			0.13	Ω	V _{GS} = 10V, I _D = 4.4A
				0.19	Ω	V _{GS} = 4.5V, I _D = 3.8A
Forward transconductance ^{(*)(‡)}	g _{fs}		4.66		S	V _{DS} = 15V, I _D = 4.4A
Dynamic ^(‡)						
Input capacitance	C _{iss}		298		pF	V _{DS} = 40V, V _{GS} =0V f=1MHz
Output capacitance	C _{oss}		35		pF	
Reverse transfer capacitance	C _{rss}		21		pF	
Switching ^(†) (‡)						
Turn-on-delay time	t _{d(on)}		1.9		ns	V _{DD} = 35V, I _D = 1A R _G ≈6.0Ω, V _{GS} = 10V
Rise time	t _r		2		ns	
Turn-off delay time	t _{d(off)}		11.5		ns	
Fall time	t _f		5.8		ns	
Total gate charge	Q _g		4.35		nC	V _{DS} = 35V, V _{GS} = 5V I _D = 4.4A
Total gate charge	Q _g		7.4		nC	V _{DS} =35V, V _{GS} = 10V I _D = 4.4A
Gate-source charge	Q _{gs}		1.06		nC	
Gate drain charge	Q _{gd}		1.8		nC	
Source-drain diode						
Diode forward voltage ^(*)	V _{SD}		0.85	0.95	V	T _j =25°C, I _S = 2.5A, V _{GS} =0V
Reverse recovery time ^(‡)	t _{rr}		19.8		ns	T _j =25°C, I _S = 2.5A, di/dt=100A/μs
Reverse recovery charge ^(‡)	Q _{rr}		14		nC	

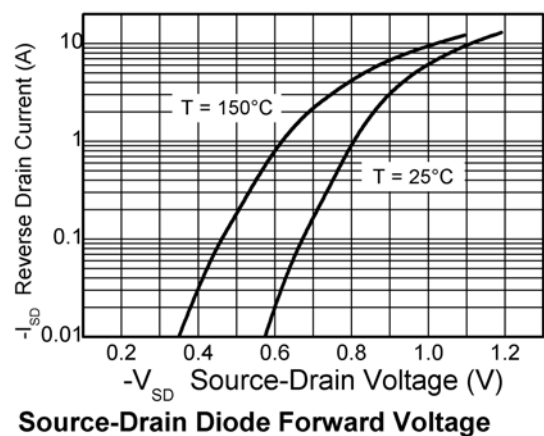
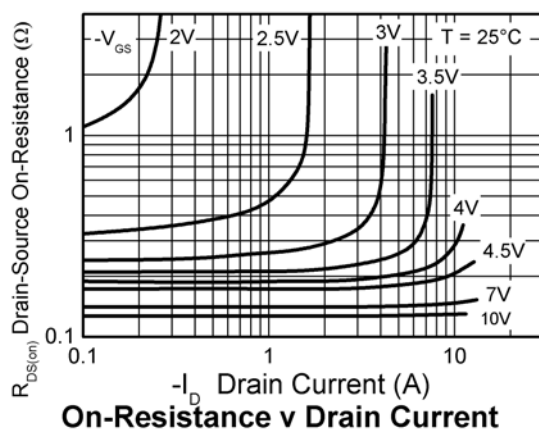
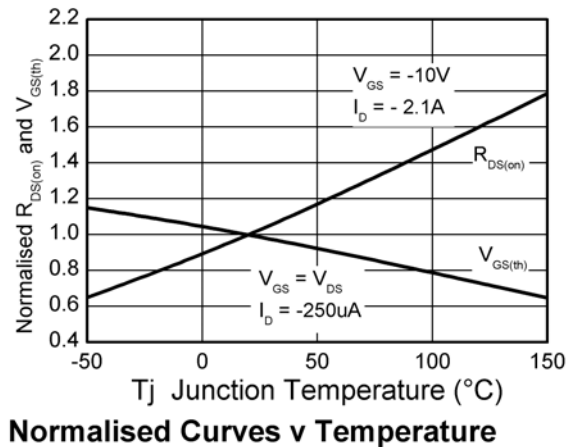
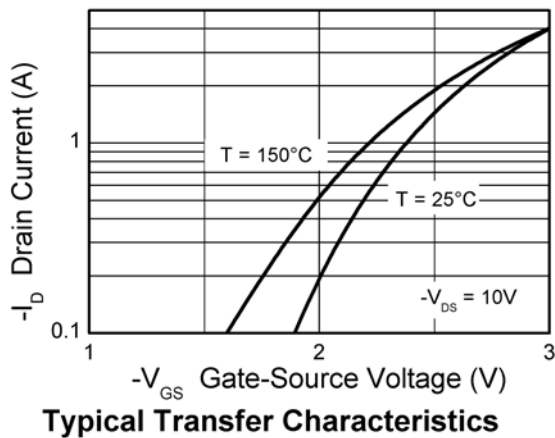
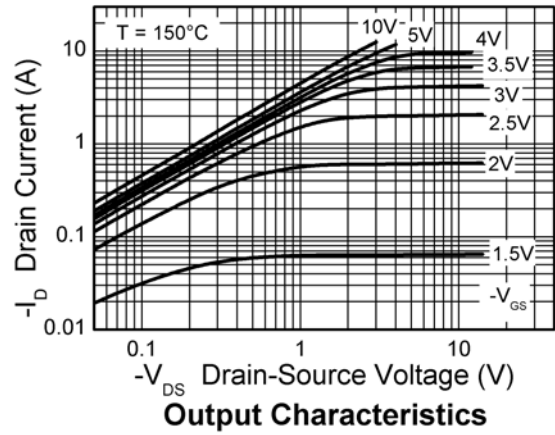
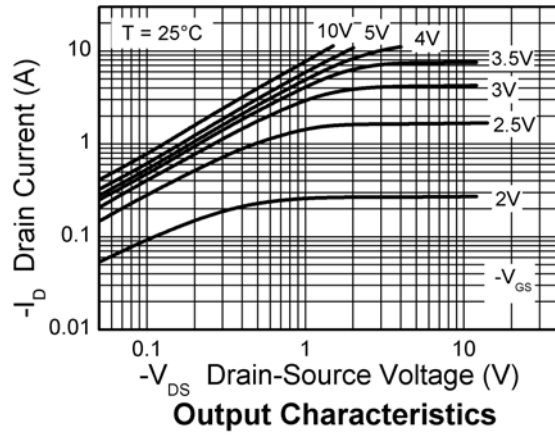
NOTES:

(*) Measured under pulsed conditions. Pulse width $\leq 300\mu s$; duty cycle $\leq 2\%$.

(†) Switching characteristics are independent of operating junction temperature.

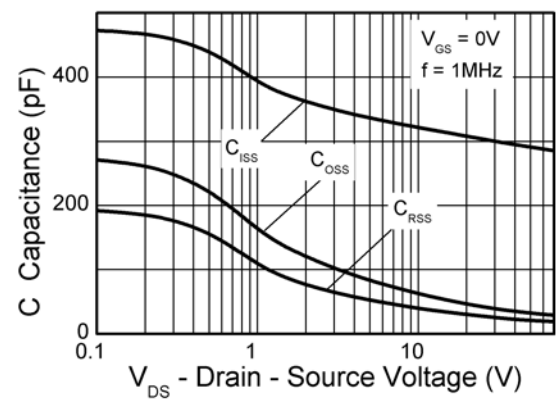
(‡) For design aid only, not subject to production testing.

Typical characteristics

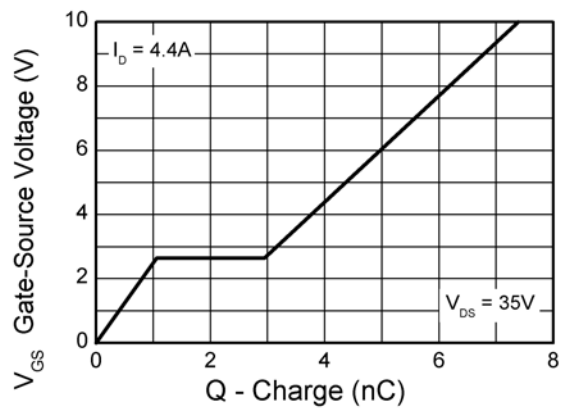


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Typical characteristics



Capacitance v Drain-Source Voltage



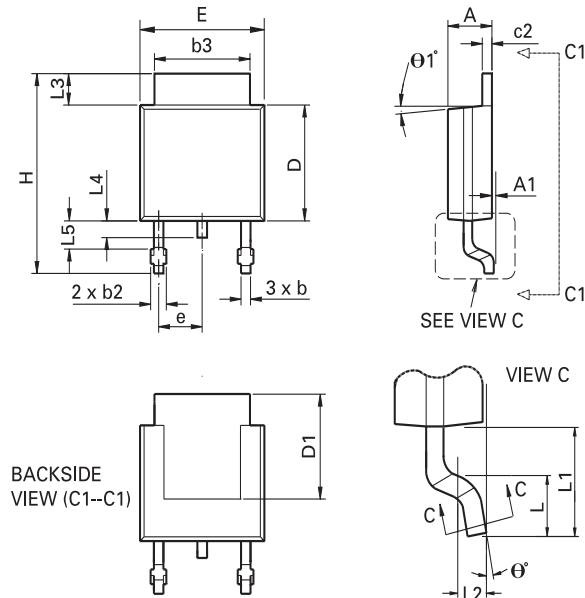
Gate-Source Voltage v Gate Charge

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Package outline - DPAK



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min	Max	Min	Max		Min	Max	Min	Max
A	0.086	0.094	2.18	2.39	e	0.090 BSC		2.29 BSC	
A1	-	0.005	-	0.127	H	0.370	0.410	9.40	10.41
b	0.020	0.035	0.508	0.89	L	0.055	0.070	1.40	1.78
b2	0.030	0.045	0.762	1.14	L1	0.108 REF		2.74 REF	
b3	0.205	0.215	5.21	5.46	L2	0.020 BSC		0.508 BSC	
c	0.018	0.024	0.457	0.61	L3	0.035	0.065	0.89	1.65
c2	0.018	0.023	0.457	0.584	L4	0.025	0.040	0.635	1.016
D	0.213	0.245	5.41	6.22	L5	0.045	0.060	1.14	1.52
D1	0.205	-	5.21	-	theta1°	0°	10°	0°	10°
E	0.250	0.265	6.35	6.73	theta°	0°	15°	0°	15°
E1	0.170	-	4.32	-	-	-	-	-	-

Note: Controlling dimensions are in inches. Approximate dimensions are provided in millimeters

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